

TAI-SAW TECHNOLOGY CO., LTD. No. 3, Industrial 2nd Rd., Ping-Chen Industrial District,

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Product Specifications Approval Sheet

Product Name: GPS L5 Band 1176.45MHz Front-End Module 1.5x1.1 mm(BW=25MHz)

TST Parts No.: TN0158A (This Part is qualified with AEC-Q100)

Customer Part No.:_____

Company:		
Division:		
Approved by :		
Date:		_
Checked by:	Jerry Xu	_
Approval by:	Jerry Xu Jerry Xu Ryan Huang 2019/09/04	_
Date:	2019/09/04	

- 1. Customer signed back is required before TST can proceed with sample build and receive orders.
- 2. Orders received without customer signed back will be regarded as agreement on the specifications.
- 3. Any specifications changes must be approved upon by both parties and a new revision of specifications shall be released to reflect the changes.

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GPS L5 Band Front-End Module 1.5x1.1 mm

MODEL NO.: TN0158A

A. GENERAL DESCRIPTION:

- 1. The TN0158A is a front-end module (FEM) designed for GPS L5 band applications.
- 2. The TN0158A offers low noise figure, high linearity, and high out-band rejection characteristics brought by included high performance pre-SAW filter and low noise amplifier (LNA).
- 3. The TN0158A offers only two external components, and very small package that is 1.5x1.1mm.

B. <u>RECOMMENDED OPERATING CONDITION</u>: (Ta=25 ℃)

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V _{DD}	1.5	-	3.42	V

C. ABSOLUTE MAXIMUM RATINGS:

- 1. Supply voltage: V_{DD}=5 V
- 2. Control voltage: V_{CTL}=5 V
- 3. Input power:
 - P_{IN} (inband): +10 dBm(V_{DD}=2.8 V, f=1176.45, 1164~1189 MHz)
 - P_{IN} (outband): +25 dBm(V_{DD}=2.8 V, f=50~1050, 1250~4000 MHz)
- 4. Power dissipation: $P_D=500 \text{ mW}(4\text{-layer FR4 PCB with through-hole}(101.5x114.5 \text{ mm}), Tj=100 ^{\circ}C)$
- 5. Terminating source impedance: Zs = 50 (Single-ended) Terminating load impedance: ZL = 50 (Single-ended)
- 6. Operating temperature range: -40 ℃ to +105 ℃
- 7. Storage temperature range: -40 ℃ to +110 ℃

D. <u>FEATURES</u>:

- 1. Low supply voltage: 1.8/ 2.8 V typ.
- 2. Low current consumption:
 - 3.0/3.7mA typ.(at V_{DD}=1.8/ 2.8 V, V_{CTL}=1.8 V)
 - 0.1µA typ.(at V_{DD}=1.8/ 2.8 V, V_{CTL}=0 V (Stand-by mode))
- 3. High gain: 17.4/18.0dB typ.(at V_{DD}=1.8/2.8 V,V_{CTL}=1.8 V, f=1176.45 MHz, 1164~1189 MHz)
- 4. Low noise figure:
 - 1.97/1.95dB typ.(at V_{DD}=1.8/ 2.8 V, V_{CTL}=1.8 V, f=1176.45 MHz)
- 5. High out band rejection(at V_{DD}=1.8/2.8 V, V_{CTL}=1.8 V):

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TST DCC Release document

REV. NO.:1.0

RoHS Compliant Lead-free soldering

Electrostatic Sensitive Device (ESD)

- 57 dBc typ.(f=704~915 MHz, relative to 1176.45 MHz)
- 58 dBc typ.(f=1710~1980 MHz, relative to 1176.45 MHz)
- 65 dBc typ.(f=2400~2500 MHz, relative to 1176.45 MHz)
- 6. Small package size: HFFP10-CD: 1.5mmx1.1mm (typ.), t=0.5mm (max.)
- 7. Moisture Sensitivity Level: Level 3

E. ELECTRICAL CHARACTERISTICS 1 (DC):

(General conditions: $T_a=+25$ °C)

Paran	Parameters Description			Min.	Тур.	Max.
Supply Voltage		V _{DD}	V	1.5	-	3.3
Control Voltage (High	ר)	$V_{\text{CTL}(H)}$	V	1.5	1.8	3.3
Control Voltage (Low	()	V _{CTL(L)}	V	0	0	0.3
Supply Current 1	RF OFF, V _{DD} =2.8 V, V _{CTL} =1.8 V	I _{DD1}	mA	-	3.7	-
Supply Current 2	RF OFF, V _{DD} =1.8 V, V _{CTL} =1.8 V	I _{DD2}	mA	-	3.0	-
Supply Current 3	Dly Current 3 RF OFF, V _{DD} =2.8 V, V _{CTL} =0 V		μA	-	0.1	3.0
Supply Current 4	RF OFF, V _{DD} =1.8 V, V _{CTL} =0 V	I _{DD4}	μA	-	0.1	3.0
Control Current	V _{CTL} =1.8 V	I _{CTL}	μA	-	5.0	12.0

F. ELECTRICAL CHARACTERISTICS 2 (RF):

(General conditions: V_{DD} =2.8 V, V_{CTL} =2.8 V, f_{RF} =1176.45 MHz, 1164~1189, T_a =+25 °C, Z_s = Z_I =50 ohm, with application circuit)

Param	Parameters Description			Min.	Тур.	Max.
Small Signal Gain (GPS)	f=1176.45MHz (GPS) Exclude PCB, Connector Losses(0.17 dB)	GainGPS1	dB	17.5	18	-
Noise Figure (GPS)	f=1176.45 MHz (GPS) Exclude PCB,Connector Losses (0.09 dB)	NFGPS1	dB		1.95	2.5
Input Power at 1dB Gain, Compression Point	f=1176.45 MHz			-	-9.8	-
	fjam=900MHz					
	fmeas=1176.45MHz	P-1dB(IN)1 OB1-1	dBm		+25	
Output Power at 1dB	at Pin=-40dBm	_0011				
Gain, Compression Point	fjam=1800MHz					
	fmeas=1176.45MHz	P-1dB(IN)1	dBm		+25	
	at Pin=-40dBm	_OB1-2				
	f1=1176.45 MHz,					
Input 3rd Order Intercept Point	f2=f1 +/-1 MHz,	IIP3_1	dBm	-	-1.5	-
	Pin=-30 dBm					

Low Band Rejection	f=704 to 915 MHz, relative to 1176.45 MHz	BR_L1	dBc	50	57	-
GPS, GNS, BeiDou Rejection	f=1559 to 1606 MHz, relative to 1176.45 MHz	BR_G1	dBc	48	53	
High Band Rejection	f=1710 to 1980 MHz, relative to 1176.45 MHz	BR_H	dBc	53	58	-
WLAN Band Rejection	f=2400 to 2500 MHz, relative to 1176.45 MHz	BR_W	dBc	60	65	-
RF IN Return Loss (GPS)	f=1176.45 MHz (GPS L5)	RLiGPS	dB	14	19	-
RF OUT Return Loss(GPS)	f=1176.45 MHz (GPS L5)	RLoGPS	dB	8	12	-
Group Delay Time Deviation	f=1164 to 1189 MHz (GPS L5)	GDTGLN1	ns	-	10	20

ELECTRICAL CHARACTERISTICS 3 (RF):

(General conditions: V_{DD} =1.8 V, V_{CTL} =1.8 V, f_{RF} =1176.45 MHz, 1164 to 1189, T_a =+25 °C, Z_s = Z_I =50 ohm, with application circuit)

Para	meters Description	Symbol	Unit	Min.	Тур.	Max.
Small Signal Gain (GPS)	f=1176.45MHz (GPS) Exclude PCB, Connector Losses(0.17 dB)	GainGPS 1	dB	16.5	17.4	-
Noise Figure (GPS)	f=1176.45 MHz (GPS) Exclude PCB,Connector Losses (0.07 dB)	NFGPS1	dB	-	1.97	2.5
Input Power at 1dB Gain, Compression Point	f=1176.45 MHz	P-1dB(IN) 1	dBm	-	-9.8	-
Input 3rd Order Intercept Point	f1=1176.45 MHz, f2=f1 +/-1 MHz, Pin=-30 dBm	IIP3_1	dBm	-	-1.5	-
Output Power at	fjam=900MHz fmeas=1176.45MHz at Pin=-40dBm	P-1dB(IN) 1_0B1-1	dBm	-	+25	-
1dB Gain, Compression Point	fjam=1800MHz fmeas=1176.45MHz at Pin=-40dBm	P-1dB(IN) 1_0B1-2	dBm	_	+25	-
Low Band Rejection	f=704 to 915 MHz, relative to 1176.45 MHz	BR_L1	dBc	50	56	-
GPS, GNS, BeiDou Rejection	f=1559 to 1606 MHz, relative to 1176.45 MHz	BR_G1	dBc	48	53	
High Band Rejection	f=1710 to 1980 MHz, relative to 1176.45 MHz	BR_H	dBc	52	58	-
WLAN Band Rejection	f=2400 to 2500 MHz, relative to 1176.45 MHz	BR_W	dBc	60	64	-
RF IN Return Loss (GPS)	f=1176.45 MHz (GPS L5)	RLiGPS	dB	14	19	-
RF OUT Return Loss(GPS)	f=1176.45 MHz (GPS L5)	RLoGPS	dB	7	11	-
Group Delay Time Deviation	f=1164 to 1189 MHz (GPS L5)	GDTGLN	ns	-	10	20

FREQUENCY CHARACTERISTICS 1:

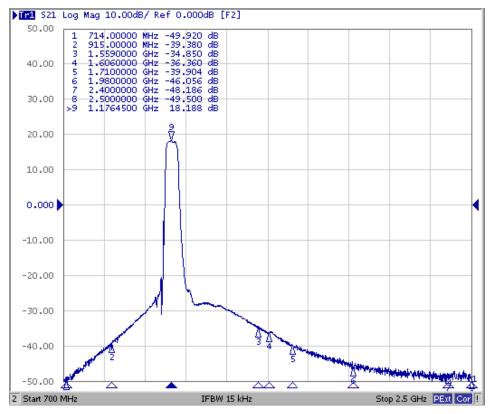
(Conditions: V_{DD} =2.8 V, V_{CTL} =2.8 V, Ta=25 °C, Z_s = Z_I =50 ohm, with application circuit.)

Transfer function:

S21 response (span: 200 MHz)

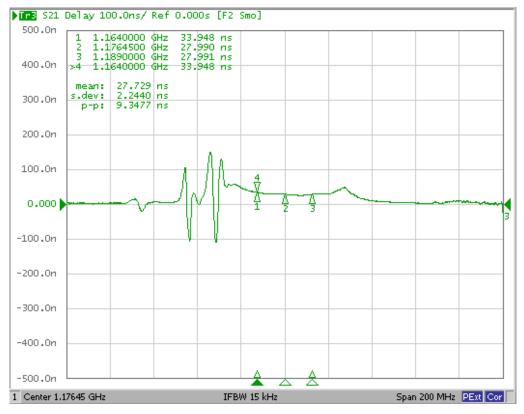


S21 response



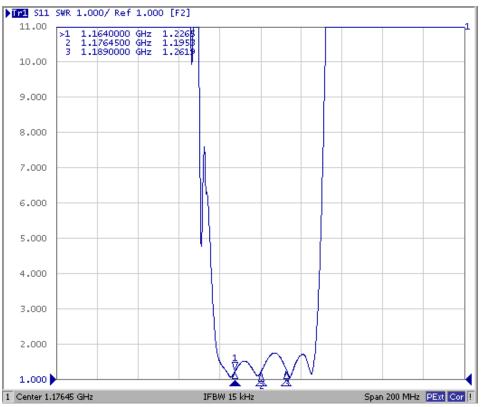
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Group Delay

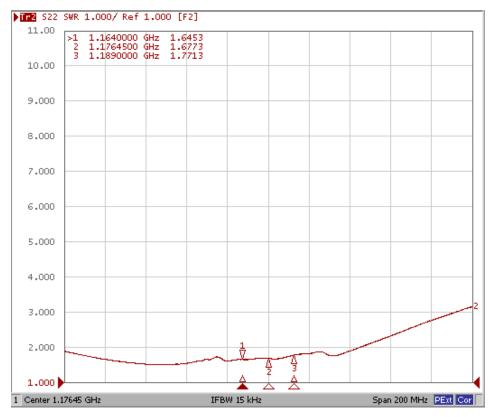


Reflection functions:

S11 VSWR

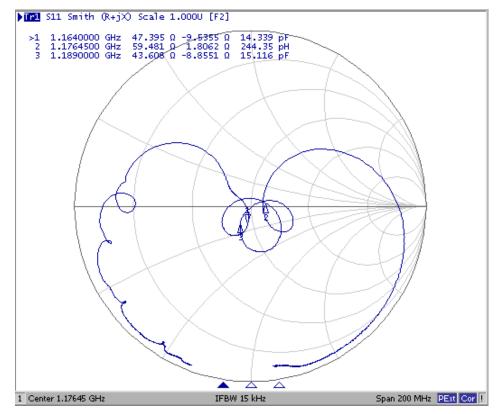


S22 VSWR

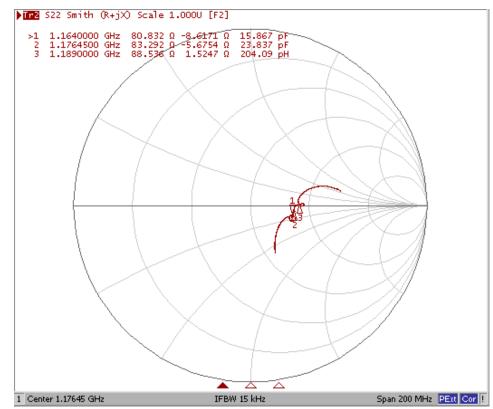


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S11 Smith Chart

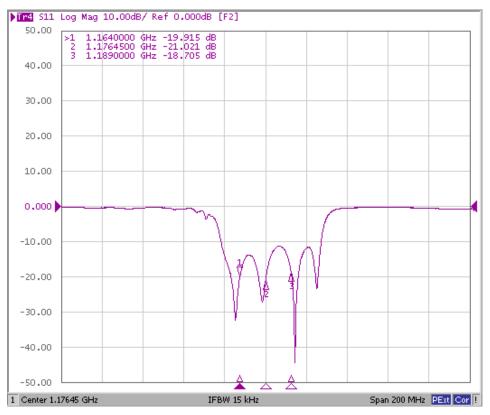


S22 Smith Chart

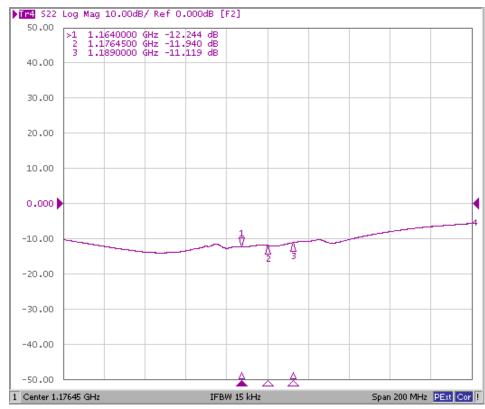


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S11 Return Loss

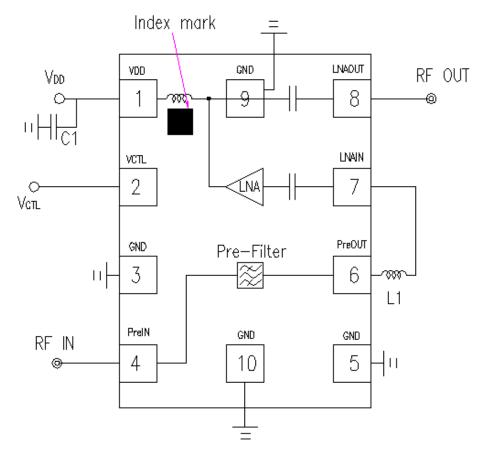


S22 Return Loss



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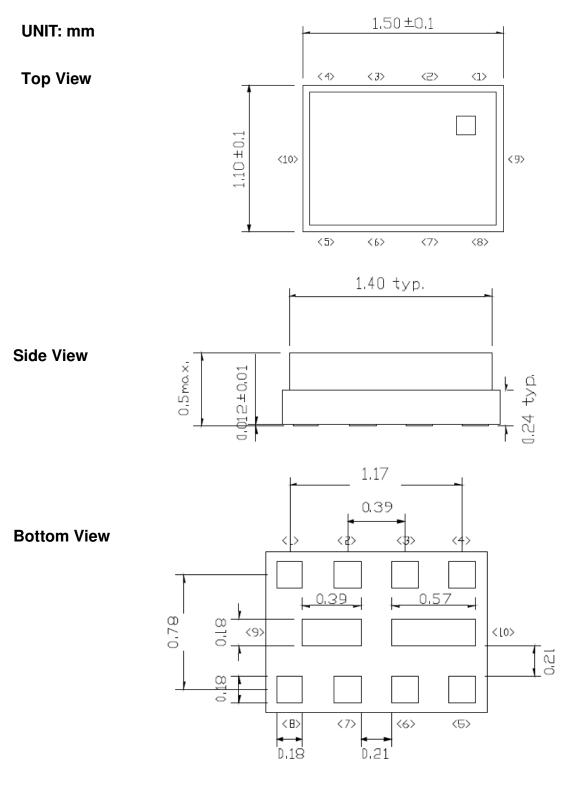
G. MEASUREMENT CIRCUIT:



Top View

Parts ID	Manufacture	Value
L1	Murata LQW15AN_00 Series	24nH
C1	Murata GRM03 Series	1000pF

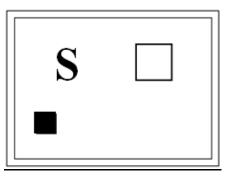
H. PACKAGE OUTLINE:



Electrode Dimensions clearance: ±0.05 mm Stand-off: 0.1 mm max. Substrate: Ceramic Terminal treat: Au Lid: Epoxy film Weight (typ.): 5 mg

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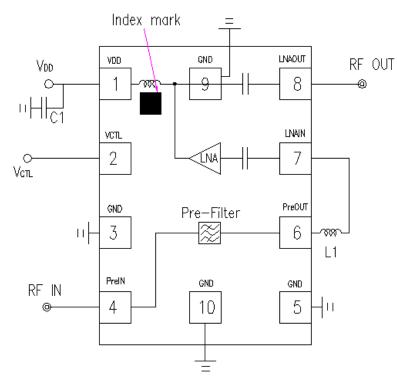
I. OUTLINE DRAWING:



: Year/Month Code (Follow the table)

YEAR/Month	1	2	3	4	5	6	7	8	9	10	11	12
2013	Α	в	C	D	E	F	U	Н	J	K	L	Μ
2014	Ν	Р	Ø	R	S	Т	υ	V	W	X	Y	Z
2015	а	b	C	d	е	f	g	h	j	k	I	m
2016	n	р	q	r	S	t	u	v	w	X	У	Z
2017	A	В	C	D	E	F	U	H	<u>J</u>	<u>K</u>	L	M
2018	N	P	Ø	<u>R</u>	<u>s</u>	<u>T</u>	U	V	W	<u>X</u>	<u>Y</u>	<u>Z</u>
2019	<u>a</u>	<u>b</u>	<u>c</u>	<u>d</u>	<u>e</u>	<u>f</u>	g	<u>h</u>	j	<u>k</u>	<u> </u>	<u>m</u>
2020	<u>n</u>	<u>p</u>	<u>q</u>	<u>r</u>	S	<u>t</u>	<u>u</u>	<u>v</u>	W	<u>×</u>	Y	<u>Z</u>

J. <u>PIN CONFIGURATION</u>:



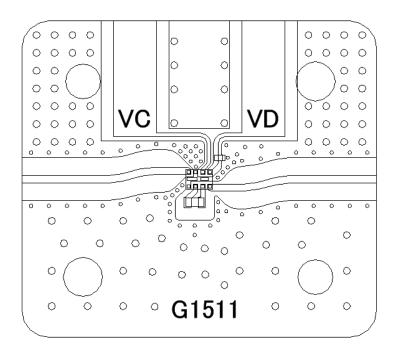
Top View

TRUTH TABLE

"H"=V _{CTL} (H), "L"=V _{CTL} (L)			
VCTL	Mode		
Н	Active mode		
L	Stand-by mode		

No.	SYMBOL	DESCRIPTION
1	VDD	Supply voltage terminal. Please connect bypass capacitor C1 with ground as close as possible.
2	VCTL	Control voltage terminal.
3	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
4	PreIN	RF input terminal. This terminal connects to input of pre-SAW filter.
5	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
6	PreOUT	Pre-SAW filter output terminal. This terminal connects to LNAIN with L1.
7	LNAIN	RF input terminal. This terminal requires only a matching inductor L1, and does not require DC blocking capacitor because of integrated capacitor.
8	LNAOUT	RF output terminal. This terminal requires no DC blocking capacitor since this terminal has integrated DC blocking capacitor.
9	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.
10	GND	Ground terminal. This terminal should be connected to the ground plane as close as possible for excellent RF performance.

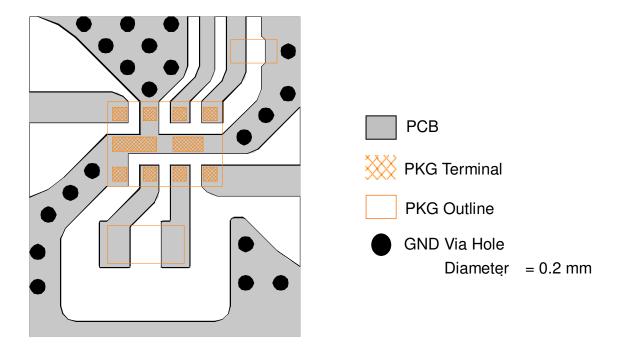
K. EVALUATION BOARD:



PCB

Substrate: TLX-9 Thickness: 0.12 mm Microstrip line width: 0.322 mm(Z_0 =50 Ω) Size: 14.0 mm x 14.0 mm

<PCB LAYOUT GUIDELINE>



PRECAUTIONS

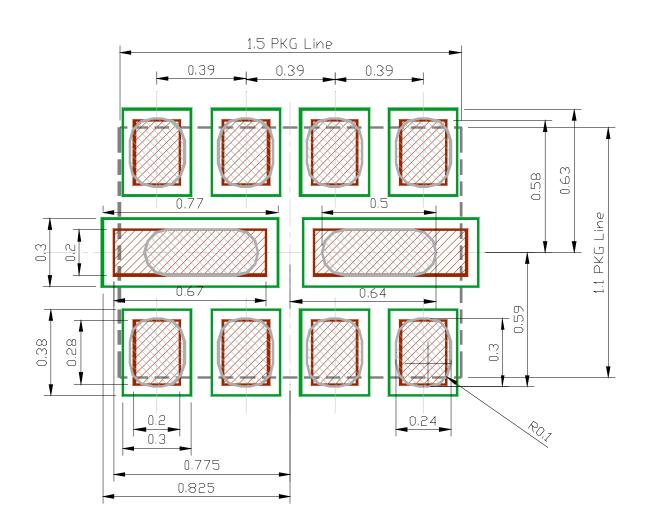
- Please layout ground pattern under this FEM in order not to couple with RFIN and RFOUT terminal.
- All external parts should be placed as close as possible to the FEM.
- For good RF performance, all GND terminals must be connected to PCB ground plane of substrate, and via-holes for GND should be placed near the FEM.

L. <u>RECOMMENDED FOOTPRINT PATTERN</u>:

PKG: 1.5 mm x 1.1 mm Pin pitch: 0.39 mm 💹 : Land

 \red{M} : Mask (Open area) *Metal mask thickness: 100 μm

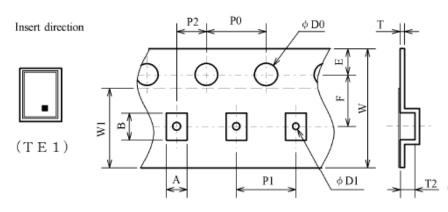
: Resist (Open area)



M. PACKING SPECIFICATION:

[TAPING DIMENSION]

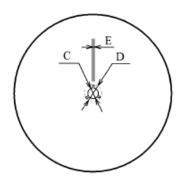
Drawing Direction

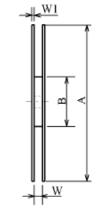


SYMBOL	DIMENSION	REMARKS
A	1.4±0.1	BOTTOM DIMENSION
В	1.8±0.1	BOTTOM DIMENSION
D0	1.5 +0.1	
D1	0.5 ± 0.05	
E	1.75±0.1	
F	3.5±0.05	
P0	4.0±0.1	
P1	4.0±0.1	
P2	2.0±0.05	
Т	0.25±0.05	
T2	0.7±0.1	
W	8.0±0.2	
W1	5.3±0.2	THICKNESS100µmMAX

*Carrier tape material: PS (Anti-static) Cover tape material: PET (Anti-static)

[REEL DIMENSION]

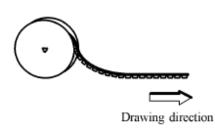


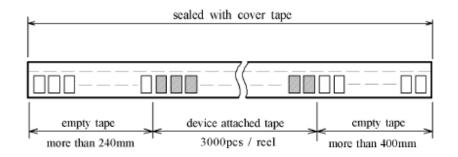


DIMENSION
φ 180 ⁺⁰ _{-1.5}
φ 66±0.5
φ 13±0.2
φ 21±0.8
2±0.5
9 ^{+1.0}
1.2

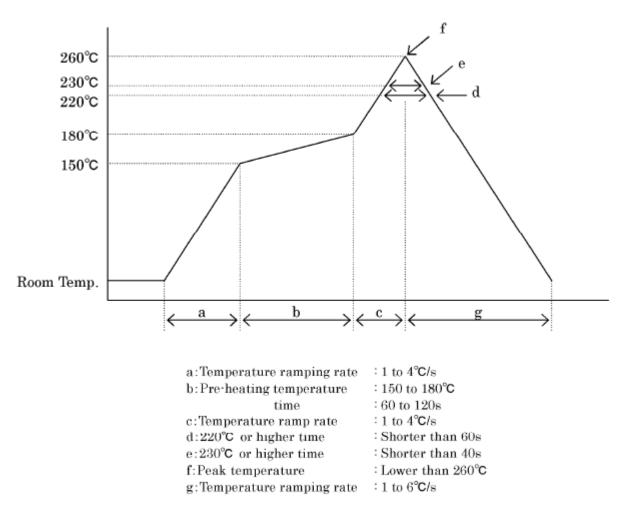
*MATERIAL : PS carbon (Anti-static)

[TAPING STATE**]**





N. <u>RECOMMENDED REFLOW PROFILE</u>:



* Recommended reflow soldering procedure

The temperature indicates at the surface of mold package.

Cautions on using this product

- This product contains Gallium-Arsenide (GaAs) which is a harmful material.
- Do NOT eat or put into mouth.
- Do NOT dispose in fire or break up this product.
- Do NOT chemically make gas or powder with this product.
- To waste this product, please obey the relating law of your country.

This product may be damaged with electric static discharge (ESD) or spike voltage. Please handle with care to avoid these damages.